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Details

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Product Status	Active
Core Processor	PIC
Core Size	16-Bit
Speed	40 MIPs
Connectivity	I ² C, IrDA, LINbus, PMP, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, POR, PWM, WDT
Number of I/O	21
Program Memory Size	128KB (43K x 24)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 3.6V
Data Converters	A/D 10x10b/12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	28-VQFN Exposed Pad
Supplier Device Package	28-QFN-S (6x6)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic24hj128gp202-e-mm

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3.0 CPU

- Note 1: This data sheet summarizes the features of the PIC24HJ32GP302/304, PIC24HJ64GPX02/X04 and PIC24HJ128GPX02/X04 families of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to Section 2. "CPU" (DS70204) of the "dsPIC33F/PIC24H Family Reference Manual", which is available from the Microchip web site (www.microchip.com).
 - Some registers and associated bits described in this section may not be available on all devices. Refer to Section 4.0 "Memory Organization" in this data sheet for device-specific register and bit information.

3.1 Overview

The PIC24HJ32GP302/304, PIC24HJ64GPX02/X04 and PIC24HJ128GPX02/X04 CPU module has a 16-bit (data) modified Harvard architecture with an enhanced instruction set and addressing modes. The CPU has a 24-bit instruction word with a variable length opcode field. The Program Counter (PC) is 23 bits wide and addresses up to 4M x 24 bits of user program memory space. The actual amount of program memory implemented varies by device. A single-cycle instruction prefetch mechanism is used to help maintain throughput and provides predictable execution. All instructions execute in a single cycle, with the exception of instructions that change the program flow, the double word move (MOV.D) instruction and the table instructions. Overhead-free, single-cycle program loop constructs are supported using the REPEAT instruction, which is interruptible at any point.

The PIC24HJ32GP302/304, PIC24HJ64GPX02/X04 and PIC24HJ128GPX02/X04 devices have sixteen, 16-bit working registers in the programmer's model. Each of the working registers can serve as a data, address or address offset register. The 16th working register (W15) operates as a software Stack Pointer (SP) for interrupts and calls.

The PIC24HJ32GP302/304, PIC24HJ64GPX02/X04 and PIC24HJ128GPX02/X04 instruction set includes many addressing modes and is designed for optimum C compiler efficiency. For most instructions, the PIC24HJ32GP302/304, PIC24HJ64GPX02/X04 and PIC24HJ128GPX02/X04 is capable of executing a data (or program data) memory read, a working register (data) read, a data memory write and a program (instruction) memory read per instruction cycle. As a result, three parameter instructions can be supported, allowing A + B = C operations to be executed in a single cycle.

A block diagram of the CPU is shown in Figure 3-1, and the programmer's model for the PIC24HJ32GP302/ 304, PIC24HJ64GPX02/X04 and PIC24HJ128GPX02/ X04 is shown in Figure 3-2.

3.2 Data Addressing Overview

The data space can be linearly addressed as 32K words or 64 Kbytes using an Address Generation Unit (AGU). The upper 32 Kbytes of the data space memory map can optionally be mapped into program space at any 16K program word boundary defined by the 8-bit Program Space Visibility Page (PSVPAG) register. The program to data space mapping feature lets any instruction access program space as if it were data space.

The data space also includes 2 Kbytes of DMA RAM, which is primarily used for DMA data transfers, but may be used as general purpose RAM.

4.2 Data Address Space

The PIC24HJ32GP302/304, PIC24HJ64GPX02/X04 and PIC24HJ128GPX02/X04 CPU has a separate 16-bit wide data memory space. The data space is accessed using separate Address Generation Units (AGUs) for read and write operations. The data memory maps are shown in Figure 4-3 and Figure 4-4.

All Effective Addresses (EAs) in the data memory space are 16 bits wide and point to bytes within the data space. This arrangement gives a data space address range of 64 Kbytes or 32K words. The lower half of the data memory space (that is, when EA<15> = 0) is used for implemented memory addresses, while the upper half (EA<15> = 1) is reserved for the Program Space Visibility area (see Section 4.6.3 "Reading Data from Program Memory Using Program Space Visibility").

PIC24HJ32GP302/304, PIC24HJ64GPX02/X04 and PIC24HJ128GPX02/X04 devices implement up to 8 Kbytes of data memory. Should an EA point to a location outside of this area, an all-zero word or byte is returned.

4.2.1 DATA SPACE WIDTH

The data memory space is organized in byte addressable, 16-bit wide blocks. Data is aligned in data memory and registers as 16-bit words, but all data space EAs resolve to bytes. The Least Significant Bytes (LSBs) of each word have even addresses, while the Most Significant Bytes (MSBs) have odd addresses.

4.2.2 DATA MEMORY ORGANIZATION AND ALIGNMENT

To maintain backward compatibility with PIC[®] MCU devices and improve data space memory usage efficiency, the PIC24HJ32GP302/304, PIC24HJ64GPX02/X04 and PIC24HJ128GPX02/X04 instruction set supports both word and byte operations. As a consequence of byte accessibility, all effective address calculations are internally scaled to step through word-aligned memory. For example, the core recognizes that Post-Modified Register Indirect Addressing mode [Ws++] results in a value of Ws + 1 for byte operations and Ws + 2 for word operations.

A data byte read, reads the complete word that contains the byte, using the LSB of any EA to determine which byte to select. The selected byte is placed onto the LSB of the data path. That is, data memory and registers are organized as two parallel byte-wide entities with shared (word) address decode but separate write lines. Data byte writes only write to the corresponding side of the array or register that matches the byte address. All word accesses must be aligned to an even address. Misaligned word data fetches are not supported, so care must be taken when mixing byte and word operations, or translating from 8-bit MCU code. If a misaligned read or write is attempted, an address error trap is generated. If the error occurred on a read, the instruction underway is completed. If the error occurred on a write, the instruction is executed but the write does not occur. In either case, a trap is then executed, allowing the system and/or user application to examine the machine state prior to execution of the address Fault.

All byte loads into any W register are loaded into the Least Significant Byte. The Most Significant Byte is not modified.

A sign-extend instruction (SE) is provided to allow user applications to translate 8-bit signed data to 16-bit signed values. Alternatively, for 16-bit unsigned data, user applications can clear the MSB of any W register by executing a zero-extend (ZE) instruction on the appropriate address.

4.2.3 SFR SPACE

The first 2 Kbytes of the Near Data Space, from 0x0000 to 0x07FF, is primarily occupied by Special Function Registers (SFRs). These are used by the PIC24HJ32GP302/304, PIC24HJ64GPX02/X04 and PIC24HJ128GPX02/X04 core and peripheral modules for controlling the operation of the device.

SFRs are distributed among the modules that they control, and are generally grouped together by module. Much of the SFR space contains unused addresses; these are read as '0'.

Note: The actual set of peripheral features and interrupts varies by the device. Refer to the corresponding device tables and pinout diagrams for device-specific information.

4.2.4 NEAR DATA SPACE

The 8 Kbyte area between 0x0000 and 0x1FFF is referred to as the near data space. Locations in this space are directly addressable via a 13-bit absolute address field within all memory direct instructions. Additionally, the whole data space is addressable using MOV instructions, which support Memory Direct Addressing mode with a 16-bit address field, or by using Indirect Addressing mode using a working register as an address pointer.

	-	•/ •/ •				••••		0.011	= (. •.										
File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets	
C1CTRL1	0400	—	—	CSIDL	ABAT	—	R	EQOP<2:0)>	OPN	/ODE<2:0	>	—	CANCAP	—	_	WIN	0480	
C1CTRL2	0402	—	—		—			—	—	—	_	—		DI	NCNT<4:0	>		0000	
C1VEC	0404	—	—			FILHIT<4:0> — ICODE<6:0>						0000							
C1FCTRL	0406	C	MABS<2:0	>	—	-	-	-	—	—	-	_	FSA<4:0>				FSA<4:0>		
C1FIFO	0408	_	_			FBP<	5:0>			—	—		FNRB<5:0>				0000		
C1INTF	040A	_	_	TXBO	TXBP	RXBP	TXWAR	RXWAR	EWARN	IVRIF	WAKIF	ERRIF	_	FIFOIF	RBOVIF	RBIF	TBIF	0000	
C1INTE	040C	—	—		—			—	—	IVRIE	WAKIE	ERRIE	—	FIFOIE	RBOVIE	RBIE	TBIE	0000	
C1EC	040E				TERRCN	NT<7:0>							RERRCN	T<7:0>				0000	
C1CFG1	0410	—	—		—			—	—	SJW<1	:0>			BRP<	5:0>			0000	
C1CFG2	0412	—	WAKFIL		—		SE	EG2PH<2:()>	SEG2PHTS	SAM	S	EG1PH<2	:0>	Р	RSEG<2:0	>	0000	
C1FEN1	0414	FLTEN15	FLTEN14	FLTEN13	FLTEN12	FLTEN11	FLTEN10	FLTEN9	FLTEN8	FLTEN7	FLTEN6	FLTEN5	FLTEN4	FLTEN3	FLTEN2	FLTEN1	FLTEN0	FFFF	
C1FMSKSEL1	0418	F7MSI	< <1:0>	F6MSI	F6MSK<1:0> F5MSK<1:0> F4M				K<1:0>	F3MSK<	<1:0>	F2MSł	<<1:0>	F1MSk	(<1:0>	FOMS	< <1:0>	0000	
C1FMSKSEL2	041A	A F15MSK<1:0> F14MSK<1:0> F13MSK<1:0> F12MSK<1:0> F11MSK<1:0> F10MSK<1:0> F10MSK<1:0> F9MSK<1:0> F8MSK<1:0>					0000												

TABLE 4-16: ECAN1 REGISTER MAP WHEN C1CTRL1.WIN = 0 OR 1 (FOR PIC24HJ128GP502/504 AND PIC24HJ64GP502/504)

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 4-17: ECAN1 REGISTER MAP WHEN C1CTRL1.WIN = 0 (FOR PIC24HJ128GP502/504 AND PIC24HJ64GP502/504)

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
	0400- 041E							Se	e definition	when WIN	= x							
C1RXFUL1	0420	RXFUL15	RXFUL14	RXFUL13	RXFUL12	RXFUL11	RXFUL10	RXFUL9	RXFUL8	RXFUL7	RXFUL6	RXFUL5	RXFUL4	RXFUL3	RXFUL2	RXFUL1	RXFUL0	0000
C1RXFUL2	0422	RXFUL31	RXFUL30	RXFUL29	RXFUL28	RXFUL27	RXFUL26	RXFUL25	RXFUL24	RXFUL23	RXFUL22	RXFUL21	RXFUL20	RXFUL19	RXFUL18	RXFUL17	RXFUL16	0000
C1RXOVF1	0428	RXOVF15	RXOVF14	RXOVF13	RXOVF12	RXOVF11	RXOVF10	RXOVF9	RXOVF8	RXOVF7	RXOVF6	RXOVF5	RXOVF4	RXOVF3	RXOVF2	RXOVF1	RXOVF0	0000
C1RXOVF2	042A	RXOVF31	RXOVF30	RXOVF29	RXOVF28	RXOVF27	RXOVF26 RXOVF25 RXOVF24 RXOVF23 RXOVF22 RXOVF21 RXOVF20 RXOVF19 RXOVF18 RXOVF17 RXOVF16					0000						
C1TR01CON	0430	TXEN1	TXABT1	TXLARB1	TXERR1	TXREQ1	RTREN1	TX1PF	RI<1:0>	TXEN0	TXABT0	TXLARB0	TXERR0	TXREQ0	RTREN0	TX0PF	RI<1:0>	0000
C1TR23CON	0432	TXEN3	TXABT3	TXLARB3	TXERR3	TXREQ3	RTREN3	TX3PF	RI<1:0>	TXEN2	TXABT2	TXLARB2	TXERR2	TXREQ2	RTREN2	TX2PF	RI<1:0>	0000
C1TR45CON	0434	TXEN5	TXABT5	TXLARB5	TXERR5	TXREQ5	RTREN5	TX5PF	RI<1:0>	TXEN4	TXABT4	TXLARB4	TXERR4	TXREQ4	RTREN4	TX4PF	RI<1:0>	0000
C1TR67CON	0436	TXEN7	TXABT7	TXLARB7	TXERR7	TXREQ7 RTREN7 TX7PRI<1:0> TXEN6 TXABT6 TXLARB6 TXER6 TXREQ6 RTREN6 TX6PRI<1:0> 000						0000						
C1RXD	0440								Received	Data Word								XXXX
C1TXD	0442								Transmit	Data Word								XXXX

Legend:

x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 4-28: PORTA REGISTER MAP FOR PIC24HJ128GP204/504, PIC24HJ64GP204/504 AND PIC24HJ32GP304

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
TRISA	02C0	_	_	_	_	_	TRISA10	TRISA9	TRISA8	TRISA7	_	_	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	079F
PORTA	02C2	_	_	_	-	_	RA10	RA9	RA8	RA7	_	_	RA4	RA3	RA2	RA1	RA0	XXXX
LATA	02C4	_	_	_	-	_	LATA10	LATA9	LATA8	LATA7	_	_	LATA4	LATA3	LATA2	LATA1	LATA0	XXXX
ODCA	02C6	—	_	-	_	_	ODCA10	ODCA9	ODCA8	ODCA7	_	—	_	_	_	_	_	0000

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 4-29: PORTB REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
TRISB	02C8	TRISB15	TRISB14	TRISB13	TRISB12	TRISB11	TRISB10	TRISB9	TRISB8	TRISB7	TRISB6	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0	FFFF
PORTB	02CA	RB15	RB14	RB13	RB12	RB11	RB10	RB9	RB8	RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0	XXXX
LATB	02CC	LATB15	LATB14	LATB13	LATB12	LATB11	LATB10	LATB9	LATB8	LATB7	LATB6	LATB5	LATB4	LATB3	LATB2	LATB1	LATB0	XXXX
ODCB	02CE	_	_	_	_	ODCB11	ODCB10	ODCB9	ODCB8	ODCB7	ODCB6	ODCB5	_	_	_	_	_	0000

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 4-30: PORTC REGISTER MAP FOR PIC24HJ128GP204/504, PIC24HJ64GP204/504 AND PIC24HJ32GP304

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
TRISC	02D0	—	-	—	—	-	—	TRISC9	TRISC8	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	03FF
PORTC	02D2	_	_	_	_	_	_	RC9	RC8	RC7	RC6	RC5	RC4	RC3	RC2	RC1	RC0	XXXX
LATC	02D4	_	_	_	_	_	_	LATC9	LATC8	LATC7	LATC6	LATC5	LATC4	LATC3	LATC2	LATC1	LATC0	XXXX
ODCC	02D6	_	-	_	-	_	_	ODCC9	ODCC8	ODCC7	ODCC6	ODCC5	ODCC4	ODCC3	-	_	_	0000

Legend: x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 4-31: SYSTEM CONTROL REGISTER MAP

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
RCON	0740	TRAPR	IOPUWR	-	_	—	_	CM	VREGS	EXTR	SWR	SWDTEN	WDTO	SLEEP	IDLE	BOR	POR	_{XXXX} (1)
OSCCON	0742	_		COSC<2	:0>	—	N	OSC<2:0>		CLKLOCK	IOLOCK	LOCK		CF	—	LPOSCEN	OSWEN	₀₃₀₀ (2)
CLKDIV	0744	ROI		DOZE<2:	:0>	DOZEN	FR	RCDIV<2:0	>	PLLPOS	ST<1:0>	—		F	PLLPRE<4	4:0>		3040
PLLFBD	0746	—	—		—	—	_	—	PLLDIV<8:0> 0						0030			
OSCTUN	0748	_	_	_		—	_	_	TUN<5:0> 01						0000			

Legend: x = unknown value on Reset, -- = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: RCON register Reset values dependent on type of Reset.

2: OSCCON register Reset values dependent on the FOSC Configuration bits and by type of Reset.

4.6.2 DATA ACCESS FROM PROGRAM MEMORY USING TABLE INSTRUCTIONS

The TBLRDL and TBLWTL instructions offer a direct method of reading or writing the lower word of any address within the program space without going through data space. The TBLRDH and TBLWTH instructions are the only method to read or write the upper 8 bits of a program space word as data.

The PC is incremented by two for each successive 24-bit program word. This allows program memory addresses to directly map to data space addresses. Program memory can thus be regarded as two 16-bit wide word address spaces, residing side by side, each with the same address range. TBLRDL and TBLWTL access the space that contains the least significant data word. TBLRDH and TBLWTH access the space that contains the upper data byte.

Two table instructions are provided to move byte or word-sized (16-bit) data to and from program space. Both function as either byte or word operations.

- TBLRDL (Table Read Low):
 - In Word mode, this instruction maps the lower word of the program space location (P<15:0>) to a data address (D<15:0>).

- In Byte mode, either the upper or lower byte of the lower program word is mapped to the lower byte of a data address. The upper byte is selected when Byte Select is '1'; the lower byte is selected when it is '0'.
- TBLRDH (Table Read High):
 - In Word mode, this instruction maps the entire upper word of a program address (P<23:16>) to a data address. The 'phantom' byte (D<15:8>), is always '0'.
 - In Byte mode, this instruction maps the upper or lower byte of the program word to D<7:0> of the data address, in the TBLRDL instruction. The data is always '0' when the upper 'phantom' byte is selected (Byte Select = 1).

Similarly, two table instructions, TBLWTH and TBLWTL, are used to write individual bytes or words to a program space address. The details of their operation are explained in Section 5.0 "Flash Program Memory".

For all table operations, the area of program memory space to be accessed is determined by the Table Page register (TBLPAG). TBLPAG covers the entire program memory space of the device, including user application and configuration spaces. When TBLPAG<7> = 0, the table page is located in the user memory space. When TBLPAG<7> = 1, the page is located in configuration space.



FIGURE 4-7: ACCESSING PROGRAM MEMORY WITH TABLE INSTRUCTIONS

REGISTER 11-1: RPINR0: PERIPHERAL PIN SELECT INPUT REGISTER 0

U-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
	—	—			INT1R<4:0>		
bit 15							bit 8
U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	_	—	—	_	—
bit 7		•				•	bit 0
Legend:							
R = Readable I	bit	W = Writable	bit	U = Unimple	mented bit, read	l as '0'	
-n = Value at P	OR	'1' = Bit is set		'0' = Bit is cle	eared	x = Bit is unkr	nown
bit 15-13	Unimplemen	ted: Read as ')'				
bit 12-8	INT1R<4:0>:	Assign Externa	al Interrupt 1	(INTR1) to the	corresponding F	RPn pin	

11111 = Input tied to Vss 11001 = Input tied to RP25	
•	
•	
•	
00001 = Input tied to RP1	
00000 = Input tied to RP0	

bit 7-0 Unimplemented: Read as '0'

REGISTER 11-2: RPINR1: PERIPHERAL PIN SELECT INPUT REGISTER 1

11.0	11.0	11.0	11.0	11.0	11.0	11.0	11.0				
0-0	0-0	0-0	0-0	0-0	0-0	0-0	0-0				
—	—	—	—			—	—				
bit 15							bit 8				
U-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1				
_	—	—			INT2R<4:0>						
bit 7							bit 0				
Legend:											
R = Readable	bit	W = Writable	bit	U = Unimplemented bit, read as '0'							
-n = Value at F	POR	'1' = Bit is set		'0' = Bit is cle	eared	x = Bit is unkr	nown				
bit 15-5	Unimplemen	ted: Read as '	0'								
bit 4-0	INTR2R<4:0>	-: Assign Exter	nal Interrupt 2	2 (INTR2) to the	e corresponding	RPn pin					
	11111 = Inpu	it tied to Vss									
	11001 = Inpu	it tied to RP25									
	•										
	•										
	•										
	00001 = Inpu	It tied to RP1									

00000 = Input tied to RP0

REGISTER 11-13: RPINR23: PERIPHERAL PIN SELECT INPUT REGISTER 23

11.0	11.0	11.0	11.0	11.0	11.0	11.0	11.0			
0-0	0-0	U-0	0-0	0-0	U-0	0-0	U-0			
_	—			—	—	—				
bit 15							bit 8			
U-0	U-0	U-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1			
—	—	—			SS2R<4:0>					
bit 7							bit 0			
Legend:										
R = Readable	bit	W = Writable I	bit	U = Unimplemented bit, read as '0'						
-n = Value at P	OR	'1' = Bit is set		'0' = Bit is cle	ared	x = Bit is unkr	nown			

bit 15-5 Unimplemented: Read as '0'

bit 4-0

SS2R<4:0>: Assign SPI2 Slave Select Input (SS2) to the corresponding RPn pin
 11111 = Input tied to Vss
 11001 = Input tied to RP25
 .

00001 = Input tied to RP1 00000 = Input tied to RP0

U-0 U-0 U-0 U-0 U-0 U-0 U-0 U-0 _ ____ _ ____ ____ ___ _ _ bit 15 bit 8 U-0 U-0 U-0 R/W-1 R/W-1 R/W-1 R/W-1 R/W-1 C1RXR<4:0> ___ bit 7 bit 0 Legend: R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

'0' = Bit is cleared

REGISTER 11-14: RPINR26: PERIPHERAL PIN SELECT INPUT REGISTER 26⁽¹⁾

bit 15-5 Unimplemented: Read as '0'

-n = Value at POR

Note 1: This register is disabled on devices without ECAN™ modules.

'1' = Bit is set

x = Bit is unknown

NOTES:

REGISTER 17-2: I2CxSTAT: I2Cx STATUS REGISTER (CONTINUED)

bit 3	S: Start bit
	 1 = Indicates that a Start (or Repeated Start) bit has been detected last 0 = Start bit was not detected last Hardware set or clear when Start, Repeated Start or Stop detected.
bit 2	R_W: Read/Write Information bit (when operating as I ² C slave)
	 1 = Read – indicates data transfer is output from slave 0 = Write – indicates data transfer is input to slave Hardware set or clear after reception of I²C device address byte.
bit 1	RBF: Receive Buffer Full Status bit 1 = Receive complete, I2CxRCV is full 0 = Receive not complete, I2CxRCV is empty Hardware set when I2CxRCV is written with received byte. Hardware clear when software reads I2CxRCV.
bit 0	TBF: Transmit Buffer Full Status bit 1 = Transmit in progress, I2CxTRN is full 0 = Transmit complete, I2CxTRN is empty Hardware set when software writes I2CxTRN. Hardware clear at completion of data transmission.





20.4 ADC Helpful Tips

- 1. The SMPI<3:0> (AD1CON2<5:2>) control bits:
 - a) Determine when the ADC interrupt flag is set and an interrupt is generated if enabled.
 - b) When the CSCNA bit (AD1CON2<10>) is set to '1', determines when the ADC analog scan channel list defined in the AD1CSSL/AD1CSSH registers starts over from the beginning.
 - c) On devices without a DMA peripheral, determines when ADC result buffer pointer to ADC1BUF0-ADC1BUFF, gets reset back to the beginning at ADC1BUF0.
- On devices without a DMA module, the ADC has 16 result buffers. ADC conversion results are stored sequentially in ADC1BUF0-ADC1BUFF regardless of which analog inputs are being used subject to the SMPI<3:0> bits (AD1CON2<5:2>) and the condition described in 1c above. There is no relationship between the ANx input being measured and which ADC buffer (ADC1BUF0-ADC1BUFF) that the conversion results will be placed in.
- On devices with a DMA module, the ADC module has only 1 ADC result buffer, (i.e., ADC1BUF0), per ADC peripheral and the ADC conversion result must be read either by the CPU or DMA controller before the next ADC conversion is complete to avoid overwriting the previous value.
- 4. The DONE bit (AD1CON1<0>) is only cleared at the start of each conversion and is set at the completion of the conversion, but remains set indefinitely even through the next sample phase until the next conversion begins. If application code is monitoring the DONE bit in any kind of software loop, the user must consider this behavior because the CPU code execution is faster than the ADC. As a result, in manual sample mode, particularly where the users code is setting the SAMP bit (AD1CON1<1>), the DONE bit should also be cleared by the user application just before setting the SAMP bit.
- 5. On devices with two ADC modules, the ADCxPCFG registers for both ADC modules must be set to a logic '1' to configure a target I/O pin as a digital I/O pin. Failure to do so means that any alternate digital input function will always see only a logic '0' as the digital input buffer is held in Disable mode.

20.5 ADC Resources

Many useful resources related to ADC are provided on the main product page of the Microchip web site for the devices listed in this data sheet. This product page, which can be accessed using this link, contains the latest updates and additional information.

Note:	In the event you are not able to access the
	product page using the link above, enter
	this URL in your browser:
	http://www.microchip.com/wwwprod-
	ucts/Devices.aspx?dDoc-
	Name=en534555

20.5.1 KEY RESOURCES

- Section 16. "Analog-to-Digital Converter (ADC)" (DS70183)
- Code Samples
- Application Notes
- Software Libraries
- Webinars
- All related dsPIC33F/PIC24H Family Reference Manuals Sections
- Development Tools

21.3 Comparator Voltage Reference

21.3.1 CONFIGURING THE COMPARATOR VOLTAGE REFERENCE

The Voltage Reference module is controlled through the CVRCON register (Register 21-2). The comparator voltage reference provides two ranges of output voltage, each with 16 distinct levels. The range to be used is selected by the CVRR bit (CVRCON<5>). The primary difference between the ranges is the size of the steps selected by the CVREF Selection bits (CVR3:CVR0), with one range offering finer resolution. The comparator reference supply voltage can come from either VDD and VSS, or the external VREF+ and VREF-. The voltage source is selected by the CVRSS bit (CVRCON<4>).

The settling time of the comparator voltage reference must be considered when changing the CVREF output.

FIGURE 21-2: COMPARATOR VOLTAGE REFERENCE BLOCK DIAGRAM



26.0 INSTRUCTION SET SUMMARY

Note:	This data sheet summarizes the
	features of the PIC24HJ32GP302/304,
	PIC24HJ64GPX02/X04 and
	PIC24HJ128GPX02/X04 families of
	devices. It is not intended to be a
	comprehensive reference source. To
	complement the information in this data
	sheet, refer to the "dsPIC33F/PIC24H
	Family Reference Manual". Please see
	the Microchip web site
	(www.microchip.com) for the latest
	dsPIC33F/PIC24H Family Reference
	Manual sections.

The PIC24H instruction set is identical to the PIC24F, and is a subset of the dsPIC30F/33F instruction set.

Most instructions are a single program memory word (24 bits). Only three instructions require two program memory locations.

Each single-word instruction is a 24-bit word, divided into an 8-bit opcode, which specifies the instruction type and one or more operands, which further specify the operation of the instruction.

The instruction set is highly orthogonal and is grouped into five basic categories:

- Word or byte-oriented operations
- Bit-oriented operations
- · Literal operations
- · Control operations

Table 26-1 shows the general symbols used in describing the instructions.

The PIC24H instruction set summary in Table 26-2 lists all the instructions, along with the status flags affected by each instruction.

Most word or byte-oriented W register instructions (including barrel shift instructions) have three operands:

- The first source operand which is typically a register 'Wb' without any address modifier
- The second source operand which is typically a register 'Ws' with or without an address modifier
- The destination of the result which is typically a register 'Wd' with or without an address modifier

However, word or byte-oriented file register instructions have two operands:

- The file register specified by the value 'f'
- The destination, which could either be the file register 'f' or the W0 register, which is denoted as 'WREG'

Most bit-oriented instructions (including simple rotate/shift instructions) have two operands:

- The W register (with or without an address modifier) or file register (specified by the value of 'Ws' or 'f')
- The bit in the W register or file register (specified by a literal value or indirectly by the contents of register 'Wb')

The literal instructions that involve data movement may use some of the following operands:

- A literal value to be loaded into a W register or file register (specified by the value of 'k')
- The W register or file register where the literal value is to be loaded (specified by 'Wb' or 'f')

However, literal instructions that involve arithmetic or logical operations use some of the following operands:

- The first source operand which is a register 'Wb' without any address modifier
- The second source operand which is a literal value
- The destination of the result (only if not the same as the first source operand) which is typically a register 'Wd' with or without an address modifier

The control instructions may use some of the following operands:

- A program memory address
- The mode of the table read and table write instructions

All instructions are a single word, except for certain double word instructions, which were made double word instructions so that all the required information is available in these 48 bits. In the second word, the 8 MSbs are '0's. If this second word is executed as an instruction (by itself), it will execute as a NOP.

Most single-word instructions are executed in a single instruction cycle, unless a conditional test is true, or the program counter is changed as a result of the instruction. In these cases, the execution takes two instruction cycles with the additional instruction cycle(s) executed as a NOP. Notable exceptions are the BRA (unconditional/computed branch), indirect CALL/GOTO, all table reads and writes and RETURN/RETFIE instructions, which are single-word instructions but take two or three cycles. Certain instructions that involve skipping over the subsequent instruction require either two or three cycles if the skip is performed, depending on whether the instruction being skipped is a single-word or double word instruction. Moreover, double word moves require two cycles. The double word instructions execute in two instruction cycles.

Note: For more details on the instruction set, refer to the *"16-bit MCU and DSC Programmer's Reference Manual"* (DS70157).

TABLE 28-4: DC TEMPERATURE AND VOLTAGE SPECIFICATIONS

DC CHARACTERISTICS			Standard (unless o Operating	Operating therwise temperat	g Condi stated) ure -4(-4(tions: 3.0)°C ≤ Ta)°C ≤Ta ≤	0V to 3.6V ≤+85°C for Industrial ≆+125°C for Extended	
Param No.	Symbol	Characteristic	Min Typ ⁽¹⁾ Max Units Conditions					
Operati	Operating Voltage							
DC10	Supply \	/oltage						
	Vdd		3.0	_	3.6	V	Industrial and Extended	
DC12	Vdr	RAM Data Retention Voltage ⁽²⁾	1.8	_	—	V	—	
DC16	VPOR	VDD Start Voltage to ensure internal Power-on Reset signal	_	_	Vss	V	_	
DC17	Svdd	VDD Rise Rate to ensure internal Power-on Reset signal	0.03	_	—	V/ms	0-3.0V in 0.1s	

Note 1: Data in "Typ" column is at 3.3V, 25°C unless otherwise stated.

2: This is the limit to which VDD can be lowered without losing RAM data.

			Standard Operating Conditions: 3.0V to 3.6V						
DC CHA	RACTER	ISTICS	Operatin	perating temperature -40° -40°			$40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial $40^{\circ}C \le TA \le +125^{\circ}C$ for Extended		
Param.	Symbol	Characteristic	Min.	Тур.	Max.	Units	Conditions		
	C I F F	Output Low Voltage I/O Pins: 2x Sink Driver Pins - RA2, RA7- RA10, RB10, RB11, RB7, RB4, RC3-RC9	_	_	0.4	V	Io∟ ≤3 mA, VDD = 3.3V See Note 1		
DO10	Vol	Output Low Voltage I/O Pins: 4x Sink Driver Pins - RA0, RA1, RB0-RB3, RB5, RB6, RB8, RB9, RB12-RB15, RC0-RC2	_	_	0.4	v	IoL ⊴6 mA, VDD = 3.3V See Note 1		
		Output Low Voltage I/O Pins: 8x Sink Driver Pins - RA3, RA4	_		0.4	V	Io∟ ≤10 mA, VDD = 3.3V See Note 1		
DO20 Voн		Output High Voltage I/O Pins: 2x Source Driver Pins - RA2, RA7-RA10, RB4, RB7, RB10, RB11, RC3-RC9	2.4	_	_	V	IOH ≥ -3 mA, VDD = 3.3V See Note 1		
	Vон	Output High Voltage I/O Pins: 4x Source Driver Pins - RA0, RA1, RB0-RB3, RB5, RB6, RB8, RB9, RB12-RB15, RC0-RC2	2.4	_	_	V	IOH ≥ -6 mA, VDD = 3.3V See Note 1		
		Output High Voltage I/O Pins: 8x Source Driver Pins - RA4, RA3	2.4	_	_	V	Іон ≥ -10 mA, Voo = 3.3V See Note 1		
		Output High Voltage	1.5	_	_		IOH ≥ -6 mA, VDD = 3.3V See Note 1		
		2x Source Driver Pins - RA2, RA7-RA10, RB4, RB7, RB10, RB11, RC3-RC9	2.0	—	—	V	IOH ≥ -5 mA, VDD = 3.3V See Note 1		
			3.0	_	—		IOH ≥ -2 mA, VDD = 3.3V See Note 1		
		Output High Voltage 4x Source Driver Pins - RA0,	1.5	_	_		Iон ≥ -12 mA, VDD = 3.3V See Note 1		
DO20A	VoH1	RA1, RB0-RB3, RB5, RB6, RB8, RB9, RB12-RB15, RC0-RC2	2.0	_	_	V	IOH ≥ -11 mA, VDD = 3.3V See Note 1		
			3.0	_	—		IOH ≥ -3 mA, VDD = 3.3V See Note 1		
		Output High Voltage I/O Pins:	1.5	_	_		IOH ≥ -16 mA, VDD = 3.3V See Note 1		
		8x Source Driver Pins - RA3, RA4	2.0	_	_	V	IoH ≥ -12 mA, VDD = 3.3V See Note 1		
				3.0	_			IOH ≥ -4 mA, VDD = 3.3V See Note 1	

TABLE 28-10: DC CHARACTERISTICS: I/O PIN OUTPUT SPECIFICATIONS

Note 1: Parameters are characterized, but not tested.

PIC24HJ32GP302/304, PIC24HJ64GPX02/X04 AND PIC24HJ128GPX02/X04

FIGURE 28-21: ECAN™ MODULE I/O TIMING CHARACTERISTICS



TABLE 28-38: ECAN™ MODULE I/O TIMING REQUIREMENTS

AC CHARACTERISTICS			Standar (unless Operatin	d Operat otherwis	ting Con se stated ature -40 -40	ditions: 3))°C ≤ TA ≤)°C ≤ TA ≤	3.0V to 3.6V +85°C for Industrial +125°C for Extended
Param No.	Symbol	Characteristic ⁽¹⁾	Min	Typ ⁽²⁾	Max	Units	Conditions
CA10	TioF	Port Output Fall Time			_	ns	See parameter D032
CA11	TioR	Port Output Rise Time		—		ns	See parameter D031
CA20	Tcwf	Pulse Width to Trigger CAN Wake-up Filter	120			ns	_

Note 1: These parameters are characterized but not tested in manufacturing.

2: Data in "Typ" column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

CHARAC	AC TERISTICS	Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤TA ≤+150°C for High Temperature						
Param No.	Symbol	Characteristic	Min	Тур	Мах	Units	Conditions	
	AD	C Accuracy (10-bit Mode)	– Measu	rements	s with Ex	ternal V	REF+/VREF- ⁽¹⁾	
HAD20b	Nr	Resolution ⁽³⁾	1	0 data bi	its	bits	—	
HAD21b	INL	Integral Nonlinearity	-3	-	3	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3.6V	
HAD22b	DNL	Differential Nonlinearity	> -1	—	< 1	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3.6V	
HAD23b	Gerr	Gain Error	-5	-	6	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3.6V	
HAD24b	EOFF	Offset Error	-1	-	5	LSb	VINL = AVSS = VREFL = 0V, AVDD = VREFH = 3.6V	
	AD	C Accuracy (10-bit Mode)	– Measu	rement	s with Int	ternal V	REF+/VREF- ⁽¹⁾	
HAD20b	Nr	Resolution ⁽³⁾	1	0 data bi	its	bits	_	
HAD21b	INL	Integral Nonlinearity	-2		2	LSb	VINL = AVSS = 0V, AVDD = 3.6V	
HAD22b	DNL	Differential Nonlinearity	> -1		< 1	LSb	VINL = AVSS = 0V, AVDD = 3.6V	
HAD23b	Gerr	Gain Error	-5		15	LSb	VINL = AVSS = 0V, AVDD = 3.6V	
HAD24b	EOFF	Offset Error	-1.5	_	7	LSb	VINL = AVss = 0V, AVDD = 3.6V	
		Dynamic P	erformar	nce (10-l	oit Mode	(2)		
HAD33b	Fnyq	Input Signal Bandwidth	_		400	kHz	—	

TABLE 29-16: ADC MODULE SPECIFICATIONS (10-BIT MODE)

Note 1: These parameters are characterized, but are tested at 20 ksps only.

2: These parameters are characterized by similarity, but are not tested in manufacturing.

3: Injection currents > | 0 | can affect the ADC results by approximately 4-6 counts.

CHARAC	AC CTERISTICS	Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤TA ≤+150°C for High Temperature					tated)
Param No.	Symbol	Characteristic	Min	Тур	Max	Units	Conditions
	Clock Parameters						
HAD50	TAD	ADC Clock Period ⁽¹⁾	147		_	ns	—
Conversion Rate							
HAD56	FCNV	Throughput Rate ⁽¹⁾			400	Ksps	_

TABLE 29-17: ADC CONVERSION (12-BIT MODE) TIMING REQUIREMENTS

Note 1: These parameters are characterized but not tested in manufacturing.

TABLE 29-18: ADC CONVERSION (10-BIT MODE) TIMING REQUIREMENTS

ر CHARAC	AC TERISTICS	Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) CS Operating temperature -40°C ≤TA ≤+150°C for High Temperature					ated)
Param No.	Symbol	Characteristic	Min	Тур	Max	Units	Conditions
	Clock Parameters						
HAD50	TAD	ADC Clock Period ⁽¹⁾	104	—	—	ns	—
Conversion Rate							
HAD56	FCNV	Throughput Rate ⁽¹⁾	_	_	800	Ksps	

Note 1: These parameters are characterized but not tested in manufacturing.

Section Name	Update Description
Section 27.0 "Electrical Characteristics"	Updated Max MIPS for temperature range of -40°C to +125°C in Table 27-1
	Updated typical values in Thermal Packaging Characteristics in Table 27-3
	Added parameters DI11 and DI12 to Table 27-9
	Updated minimum values for parameters D136 (TRW) and D137 (TPE) and removed typical values in Table 27-12
	Added Extended temperature range to Table 27-13
	Updated parameter AD63 and added Note 3 to Table 27-38 and Table 27-39

TABLE A-1: MAJOR SECTION UPDATES (CONTINUED)

NOTES: